

Product Compliance Declaration

Please see www.molex.com for the most up-to-date information.

Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Number 0015916062 Part Weight 0.363783G

Part Name CGrid SMT Bkwy Hdr 15"SAu 6Ckt T&R

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
CGrid SMT Bkwy Hdr 15"SAu 6Ckt T&R	Assembly		100	0.363783	
CGrid SMT Bkwy Hdr 15 SAu 6Ckt Bulk	Assembly		100	0.363783	
.440 X .0255 Sq Pin 15GOLD Plate	Assembly		66.034	0.240221	
.440 x .0255 Sq Bandolier Pin Unplated	Component		62.6747	0.228	
Cartridge Brass 70% Unplated	Material		62.6747	0.228	
Copper	Substance	7440-50-8	7440-50-8 43.8723		
Zinc (metal)	Substance	7440-66-6	18.8024	0.0684	
Gold Plating	Material		0.5016	0.001825	
Cobalt	Substance	7440-48-4	0.0013	0.000005	
Nickel	Substance	7440-02-0	0.0013	0.000005	
Gold	Substance	7440-57-5	7440-57-5 0.4991		
Nickel Plating	Material		2.1441	0.0078	
Nickel	Substance	7440-02-0	2.1439	0.007799	

Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
Further Additives	Substance	system	0.0002	8E-07	
Tin Plating	Material		0.7137	0.002596	
Tin	Substance	7440-31-5	0.7137	0.002596	
COMPONENT CGrid Bkwy Hsg 100Ckt	Component		33.966	0.123563	
LCP GF30 BLACK	Material		33.966	0.123563	
BASIC POLYMER: LCP	Substance		23.3346	0.084887	
Further Additives	Substance	system	0.1019	0.000371	
GF-FIBRE	Substance		10.1898	0.037069	
Carbon black	Substance	1333-86-4	0.3397	0.001236	

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)4578-DC (25 June 2020)

Contained Substances Exceeding Threshold

None

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added	
Lead	Cartridge Brass 70% (CA260)	*Note	350	Yes	
Lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	150	Yes	
Nickel	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes	
Nickel	Ep-Ni	*Note	997,500	Yes	
Cobalt	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes	
Copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes	
Glass fibres	LCP GF30 BLACK	*Note	300,000	Yes	

^{*}Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Exemptions

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits
e-plate Au (Hardgold) (electrodeposited Hardgold Coatings)	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/cm2/week)
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/cm2/week)

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

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T&R





Hazardous Substances

Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
CGrid SMT Bkwy Hdr 15"SAu 6Ckt T&R	0	0	0	0	0	0
CGrid SMT Bkwy Hdr 15 SAu 6Ckt Bulk	0	0	0	0	0	0
.440 X .0255 Sq Pin 15GOLD Plate	0	0	0	0	0	0
.440 x .0255 Sq Bandolier Pin Unplated	0	0	0	0	0	0
COMPONENT CGrid Bkwy Hsg 100Ckt	0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	N/A
Termination Base Alloy	N/A
Solder Alloy	N/A
Process Capability	REFLOW
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	260
Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

Aug 5, 2020